TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC

# TLP3061(S), TLP3062(S), TLP3063(S)

OFFICE MACHINE HOUSEHOLD USE EQUIPMENT

TRIAC DRIVER

SOLID STATE RELAY

The TOSHIBA TLP3061 (S), TLP3062 (S) and TLP3063 (S) consist of a zero voltage crossing turn-on photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

All parameters are tested to the specification of TLP3061, TLP3062, TLP3063.

Peak Off-State Voltage: 600V (min)

Trigger LED Current : 15mA (max) (TLP3061)

10mA (max) (TLP3062) 5mA (max) (TLP3063)

On-State Current : 100mA (max)

: UL1577, File No. E67349 **UL** Recognized

Isolation Voltage :  $5000V_{rms}$  (min) **SEMKO** Approved : SS EN60065 SS EN60950

: BS EN60065

**BS EN60950** 

Option (D4) Type

**BSI** Approved

VDE Approved : DIN VDE0884/06.92

Certificate No. 68329

Maximum Operating Insulation Voltage: 890Vpk Highest Permissible Over Voltage

When a VDE0884 approved type is needed, please designate the "Option (D4)"

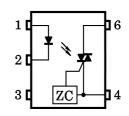
#### **Device Construction**

	7.62mm pich standard type	10.16mm pich (LF2) type
Creepage Distance	7.0mm (min)	8.0mm (min)
Clearance	7.0mm (min)	8.0mm (min)
Insulation Thickness	0.5mm (min)	0.5mm (min)

Unit in mm  $7.12 \pm 0.25$  $7.62 \pm 0.25$ 0.25 +0.1 7.85~8.80 **JEDEC EIAJ TOSHIBA** 11-7A9

Weight: 0.39g

PIN CONFIGURATION (Top view)



1: ANODE 2: CATHODE 3: N.C.

4: TERMINAL 1 6: TERMINAL 2

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#### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC			SYMBOL	RATING	UNIT
Forward Current			Ι <sub>Γ</sub>	50	mA
	Forward Current Derating (Ta≥53°C)			-0.7	mA/°C
	Peak Forward Current		I <sub>FP</sub>	-1	Α
l a	$(100\mu  ext{s}  ext{ pulse}, 100 ext{pps})$			1	A
LE	Power Dissipation		$P_{\mathrm{D}}$	100	mW
	Power Dissipation Derating (Ta≥	25°C)	$\Delta P_{\mathbf{D}}/^{\circ}C$	-1.0	mW/°C
	Reverse Voltage			5	V
	Junction Temperature			125	°C
	Off-State Output Terminal Volta	ge	$v_{ m DRM}$	600	V
	On State DMS Comment	Ta = 25°C	I <sub>T</sub> (RMS)	100	mA
	On-State RMS Current	$Ta = 70^{\circ}C$		50	mA
OR	On-State Current Derating (Ta≥	ΔI <sub>T</sub> /°C	-1.1	mA/°C	
	Peak On-State Current	$I_{\mathrm{TP}}$	2	A	
ΕC	○ (100µs pulse, 120pps) □ Peak Nonrepetitive Surge Current □ (P <sub>w</sub> =10ms, DC=10%)				A
ΕT				1.2	A
	$ \bigcap_{\mathbf{Q}} \left[ (\mathbf{P}_{\mathbf{W}} = 10 \text{ms, DC} = 10\%) \right] $		ITSM		
	Power Dissipation		$P_{\mathrm{D}}$	300	mW
	Power Dissipation Derating (Ta≥	≧ 25°C)	$\Delta P_{\mathbf{D}}/^{\circ}\mathbf{C}$ $T_{\mathbf{i}}$	-4.0	mW/°C
	Junction Temperature			115	°C
	orage Temperature Range		$ m T_{stg}$	-55~150	°C
Operating Temperature Range			${ m T_{opr}}$	-40~100	°C
Lead Soldering Temperature (10s)			$T_{ m sol}$	260	°C
Total Package Power Dissipation			$P_{\mathrm{T}}$	330	mW
Total Package Power Dissipation Derating (Ta≥25°C)			$\Delta P_{\mathrm{T}}/^{\circ}\mathrm{C}$	-4.4	mW/°C
Isolation Voltage (AC, 1min., R.H.≦60%) (Note 1)		$BV_{\mathbf{S}}$	5000	Vrms	

Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

### RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	$v_{AC}$	_	_	240	Vac
Forward Current	$ m I_{F}^*$	15	20	25	mA
Peak On-State Current	$I_{ ext{TP}}$	_	_	1	A
Operating Temperature	$T_{ m opr}$	-25	_	85	°C

<sup>\*</sup> In the case of TLP3062

000707EBC2

Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

The products described in this document are subject to the foreign exchange and foreign trade laws.

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The information contained herein is subject to change without notice.

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INDIVIDUAL	LLLCINICAL	CHANACILINISTICS (1a – 2	J ()

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
D	Forward Voltage	$V_{\mathbf{F}}$	$I_{\mathbf{F}} = 10 \text{mA}$	1.0	1.15	1.3	V
LE	Reverse Current	$I_{ m R}$	$V_R=5V$	_	_	10	$\mu$ A
Ľ	Capacitance	$\mathrm{c_{T}}$	V=0, f=1MHz		10	_	pF
	Peak Off-State Current	$I_{ m DRM}$	$V_{ m DRM}$ = 600V	_	10	1000	nA
ETECTOR	Peak On-State Voltage	$ m V_{TM}$	$I_{TM} = 100 mA$	_	1.7	3.0	V
	Holding Current	${ m I_{H}}$	_	_	0.6	_	mA
	Critical Rate of Rise of Off-State Voltage	dv / dt	V <sub>in</sub> =240Vrms, Ta=85°C (Fig.1)	200	500	_	V/μs
D	Critical Rate of Rise of Commutating Voltage	dv / dt (c)	$V_{in}$ =60Vrms, $I_T$ =15mA (Fig.1)		0.2	_	V/μs

## COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
	TLP3061			_	_	15		
Trigger LED Current	TLP3062	$ m I_{FT}$	$V_{\mathrm{T}}=6V$	_	5	10	mA	
	TLP3063	1			_	5		
Inhibit Voltage		$v_{ m IH}$	I <sub>F</sub> =Rated I <sub>F</sub> T	_	_	50	V	
Leakage in Inhibited State		$I_{\mathrm{IH}}$	I <sub>F</sub> =Rated I <sub>F</sub> T V <sub>T</sub> =Rated V <sub>DRM</sub>	_	100	300	$\mu$ A	
Capacitance Input to Output		$c_{S}$	$V_S=0$ , $f=1MHz$	_	0.8	_	pF	
Isolation Resistance		RS	$V_S = 500V (R.H. \le 60\%)$	$5 \times 10^{10}$	1014	_	Ω	
Isolation Voltage		$BV_{\mathbf{S}}$	AC, 1 minute	5000	_	_	Vrms	
			AC, 1 second, in oil	_	10000	_	Vrms	
			DC, 1 minute, in oil	_	10000	_	$V_{dc}$	

Fig. 1 dv/dt TEST CIRCUIT

